

PRELIMINARY
Notice: This is not a final specification.
Some parametric limits are subject to change.

HVDi (High Voltage Diode) Module

MITSUBISHI FAST RECOVERY DIODE MODULE

RM400DY-66S

HIGH POWER, HIGH SPEED SWITCHING USE
INSULATED TYPE

RM400DY-66S



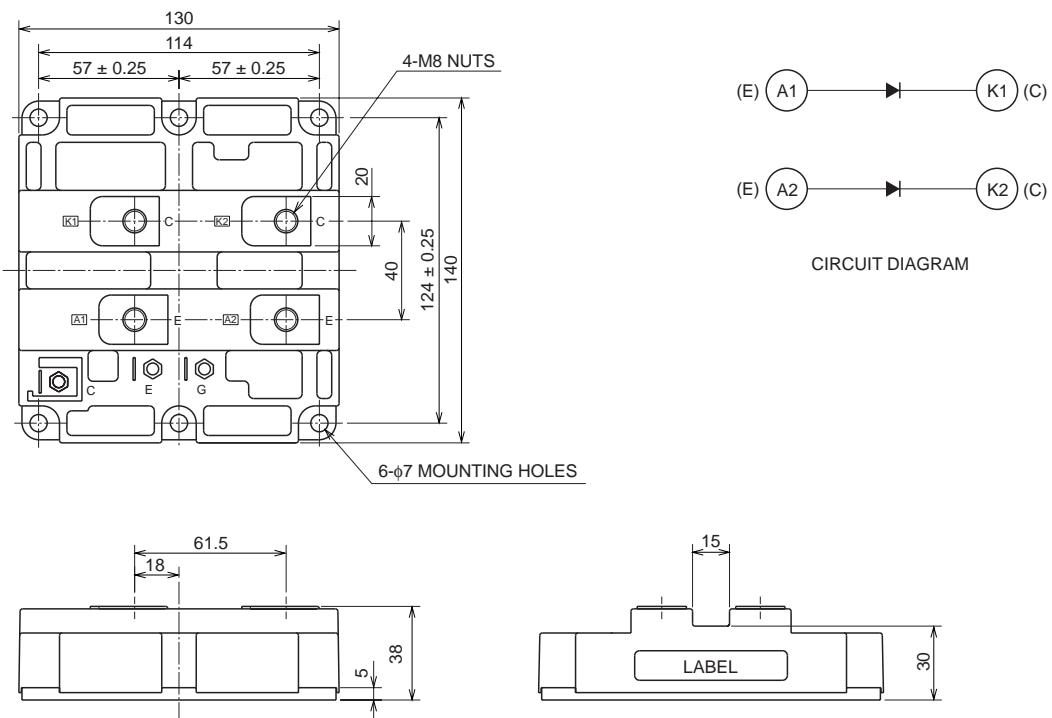
- IDC 400A
- VRMM 3300V
- Insulated type
- 2-elements in a pack

APPLICATION

3-level inverters, 3-level converters, DC choppers.

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



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**HIGH POWER, HIGH SPEED SWITCHING USE
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ABSOLUTE MAXIMUM RATINGS ($T_j = 25^\circ\text{C}$)

Symbol	Parameter	Voltage class	Unit
		66	
VR _{RM}	Repetitive peak reverse voltage	3300	V
V _{DRM}	Non-repetitive peak reverse voltage	3300	V
V _{R(DC)}	Reverse DC voltage	2200	V

Symbol	Parameter	Conditions	Ratings	Unit
I _{DC}	DC current	T _C = 25°C	400	A
I _{FMS}	Surge (non-repetitive) forward current	1 cycle of half wave 60Hz, peak value, T _j = 25°C start, VRM = 0V	3200	A
I ² t	I ² t for fusing	Value of one cycle surge current, t _w = 8.3ms, T _j = 25°C start	4.27 X 10 ⁴	A ² s
T _j	Junction temperature	—	-40 ~ +150	°C
T _{stg}	Storage temperature	—	-40 ~ +125	°C
V _{iso}	Isolation Voltage	Main terminal to case, 60Hz, sinusoidal, AC, 1min, rms	6000	V
—	Mounting torque	Main terminals screw : M6	6.67 ~ 8.24	N · m
—		Mounting screw : M6	2.84 ~ 3.43	N · m
—	Weight	Typical value	1.5	kg

ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
I _{RRM}	Repetitive reverse current	VR _{RM} applied, VRM = VR _{RM}	—	—	3	mA
V _{FM}	Forward voltage	I _{FM} = 400A, t _w ≤ 1ms	—	3.30	4.29	V
t _{rr}	Reverse recovery time	I _{FM} = 400A, dI/dt = -800A/μs,	—	—	1.20	μs
Q _{rr}	Reverse recovery charge	VR = 1650V	—	100	—	μC
R _{th(j-c)}	Termal resistance	Junction to case (Per 1/2 module)	—	—	0.072	°C/W
R _{th(c-f)}	Contact thermal resistance	Case to fin, thermal grease applied (Per 1/2 module)	—	0.036	—	°C/W